

## IN THE CLAIMS:

The text of all pending claims, (including withdrawn claims) is set forth below. Cancelled and not entered claims are indicated with claim number and status only. The claims as listed below show added text with underlining and deleted text with ~~striketrough~~. The status of each claim is indicated with one of (original), (currently amended), (cancelled), (withdrawn), (new), (previously presented), or (not entered).

Please AMEND claims 3, 7, 10, 15 and 26 and CANCEL claims 1, 2, 6, 14, 17-25 and 27 without prejudice or disclaimer of the subject matter recited therein in accordance with the following:

1. (Cancelled)
2. (Cancelled)
3. (Currently Amended) A method of manufacturing an organic electroluminescent display device, the method comprising:
  - preparing an auxiliary substrate, which has a flat side and is non-flexible;
  - forming a first protective layer on the auxiliary substrate, ~~the first protective layer being insoluble in a liquid etchant;~~
  - forming an organic electroluminescent unit on the first protective layer;
  - bonding a flexible main substrate onto the organic electroluminescent unit; ~~and~~
  - etching the auxiliary substrate to remove the auxiliary substrate; and
  - forming a third protective layer for protecting the flexible main substrate on the flexible main substrate, after the bonding of the flexible main substrate.
4. (Original) The method of claim 3, further comprising forming a second protective layer for planarizing the organic electroluminescent unit to be disposed between the organic electroluminescent unit and the flexible main substrate, before bonding the flexible main substrate.
5. (Original) The method of claim 3, wherein forming the organic electroluminescent unit comprises:
  - forming a thin-film transistor layer on the first protective layer;

forming a first electrode layer on the first protective layer to be electrically connected to the thin-film transistor layer;

forming an insulation layer such that a predetermined portion of the first electrode layer is exposed;

forming an organic layer on the first electrode layer; and

forming a second electrode layer on the insulation layer exposing the organic layer.

6. (Cancelled)

7. (Currently Amended) The method of claim 3, wherein the etching of the auxiliary substrate is performed using a liquid etchant which etches a glass material.

8. (Original) The method of claim 7, wherein the liquid etchant is one selected from the group consisting of hydrofluoric acid, hydrochloric acid, and a mixture thereof.

9. (Original) The method of claim 3, further comprising forming an organic layer protector, protecting the organic electroluminescent unit, on the first protection layer from which the auxiliary substrate is removed, after etching the auxiliary substrate.

10. (Currently Amended) A method of manufacturing an organic electroluminescent display device, the method comprising:

preparing an auxiliary substrate, which has a flat side;

forming a first protective layer on the auxiliary substrate, ~~the first protective layer being insoluble in a liquid etchant;~~

forming an organic electroluminescent unit on the first protective layer;

bonding a flexible main substrate onto the organic electroluminescent unit; ~~and~~

etching the auxiliary substrate to have a thickness allowing flexibility; and

forming a third protective layer protecting the flexible main substrate on the flexible main substrate, after the bonding of the flexible main substrate.

11. (Original) The method of claim 10, wherein the auxiliary substrate is made of glass, and the flexible main substrate is made of a synthetic resin material having flexibility.

12. (Original) The method of claim 10, further comprising forming a second

protective layer for planarizing the organic electroluminescent unit, to be disposed between the organic electroluminescent unit and the flexible main substrate, before bonding the flexible main substrate.

13. (Original) The method of claim 10, wherein forming the organic electroluminescent unit comprises:

- forming a thin-film transistor layer on the first protective layer;
- forming a first electrode layer on the first protective layer to be electrically connected to the thin-film transistor layer;
- forming an insulation layer such that a predetermined portion of the first electrode layer is exposed;
- forming an organic layer on the first electrode layer; and
- forming a second electrode layer on the insulation layer exposing the organic layer.

14. (Cancelled)

15. (Currently Amended) The method of claim 10, wherein the etching of the auxiliary substrate is performed using a liquid etchant which is one selected from the group consisting of hydrofluoric acid, hydrochloric acid, and a mixture thereof.

16. (Original) The method of claim 10, further comprising forming an organic layer protector protecting the organic electroluminescent unit on the first protection layer from which the auxiliary substrate is removed, after etching the auxiliary substrate.

17-25. (Cancelled)

26. (Currently Amended) A process of preparing a product comprising an organic electroluminescent display device having a flat first protective layer wherein the first protective layer is insoluble in a liquid etchant, at least one thin-film layer on the first protective layer and a flexible main substrate bonding onto the thin-film layer, the process comprising:

- preparing an auxiliary substrate, which has at least one flat side;
- forming a first protective layer on the auxiliary substrate, the first protective layer being insoluble in a liquid etchant;
- forming at least one thin-film layer on the first protective layer;

bonding a flexible main substrate onto the thin-film layer; ~~and~~  
etching the auxiliary substrate to remove the auxiliary substrate; and  
forming a third protective layer for protecting the flexible main substrate from the liquid  
etchant on the flexible main substrate, after the bonding of the flexible main substrate.

27. (Cancelled)